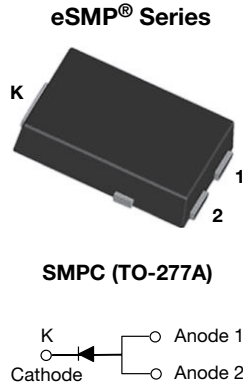


# High Current Density Surface Mount TMBS<sup>®</sup> (Trench MOS Barrier Schottky) Rectifier

 Ultra Low  $V_F = 0.37\text{ V}$  at  $I_F = 4\text{ A}$ 


## FEATURES

- Very low profile - typical height of 1.1 mm
- Ideal for automated placement
- Trench MOS Schottky technology
- Low forward voltage drop, low power losses
- High efficiency operation
- Meets MSL level 1, per J-STD-020, LF maximum peak of 260 °C
- AEC-Q101 qualified available  
- Automotive ordering code; base P/NHM3
- Material categorization: for definitions of compliance please see [www.vishay.com/doc?99912](http://www.vishay.com/doc?99912)

 AUTOMOTIVE  
GRADE  
Available

**RoHS**  
COMPLIANT  
HALOGEN  
**FREE**

## ADDITIONAL RESOURCES


[3D Models](#)

| PRIMARY CHARACTERISTICS                                 |                |
|---|----------------|
| $I_{F(AV)}$   | 8.0 A          |
| $V_{RRM}$   | 60 V           |
| $I_{FSM}$   | 140 A          |
| $V_F$ at $I_F = 8.0\text{ A}$ ( $T_A = 125\text{ °C}$ ) | 0.46 V         |
| $T_J$ max.  | 150 °C         |
| Package   | SMPC (TO-277A) |
| Circuit configuration                                   | Single         |

## TYPICAL APPLICATIONS

For use in low voltage high frequency inverters, freewheeling, DC/DC converters, and polarity protection applications.

## MECHANICAL DATA

**Case:** SMPC (TO-277A)

Molding compound meets UL 94 V-0 flammability rating  
Base P/N-M3 - halogen-free, RoHS-compliant, and commercial grade

Base P/NHM3\_X - halogen-free, RoHS-compliant, and AEC-Q101 qualified

("\_X" denotes revision code e.g. A, B,.....)

**Terminals:** matte tin plated leads, solderable per J-STD-002 and JESD 22-B102

M3 suffix meets JESD 201 class 2 whisker test, HM3 suffix meets JESD 201 class 2 whisker test

| MAXIMUM RATINGS ( $T_A = 25\text{ °C}$ unless otherwise noted)                    |                |             |            |
|---|----------------|-------------|------------|
| PARAMETER   | SYMBOL         | V8P6        | UNIT       |
| Device marking code   |                | V86         |            |
| Maximum repetitive peak reverse voltage   | $V_{RRM}$      | 60          | V          |
| Maximum average forward rectified current (fig. 1)                                | $I_F^{(1)}$    | 8.0         | A          |
|   | $I_F^{(2)}$    | 4.2         |            |
| Peak forward surge current 10 ms single half sine-wave superimposed on rated load | $I_{FSM}$      | 140         | A          |
| Voltage rate of change (rated $V_F$ )   | dV/dt          | 10 000      | V/ $\mu$ s |
| Operating junction and storage temperature range                                  | $T_J, T_{STG}$ | -40 to +150 | °C         |

## Notes

(1) Mounted on 30 mm x 30 mm pad areas aluminum PCB

(2) Free air, mounted on recommended copper pad area



| ELECTRICAL CHARACTERISTICS ( $T_A = 25\text{ }^\circ\text{C}$ unless otherwise noted) |                      |                                   |             |      |      |      |
|---|----------------------|-----------------------------------|-------------|------|------|------|
| PARAMETER   | TEST CONDITIONS      |                                   | SYMBOL      | TYP. | MAX. | UNIT |
| Instantaneous forward voltage   | $I_F = 4.0\text{ A}$ | $T_A = 25\text{ }^\circ\text{C}$  | $V_F^{(1)}$ | 0.46 | -    | V    |
|   | $I_F = 8.0\text{ A}$ |                                   |             | 0.53 | 0.61 |      |
|   | $I_F = 4.0\text{ A}$ | $T_A = 125\text{ }^\circ\text{C}$ |             | 0.37 | -    |      |
|   | $I_F = 8.0\text{ A}$ |                                   |             | 0.46 | 0.55 |      |
| Reverse current   | $V_R = 60\text{ V}$  | $T_A = 25\text{ }^\circ\text{C}$  | $I_R^{(2)}$ | -    | 0.6  | mA   |
|   |                      | $T_A = 125\text{ }^\circ\text{C}$ |             | 7.0  | 25   |      |

**Notes**

- (1) Pulse test: 300  $\mu\text{s}$  pulse width, 1 % duty cycle  
(2) Pulse test: pulse width  $\leq 5\text{ ms}$

| THERMAL CHARACTERISTICS ( $T_A = 25\text{ }^\circ\text{C}$ unless otherwise noted) |                          |      |                    |
|--|--------------------------|------|--------------------|
| PARAMETER  | SYMBOL                   | V8P6 | UNIT               |
| Typical thermal resistance   | $R_{\theta JA}^{(1)(2)}$ | 75   | $^\circ\text{C/W}$ |
|  | $R_{\theta JM}^{(3)}$    | 4    |                    |

**Notes**

- (1) The heat generated must be less than the thermal conductivity from junction to ambient:  $dP_D/dT_J < 1/R_{\theta JA}$   
(2) Free air mounted on recommended copper pad area; thermal resistance  $R_{\theta JA}$  - junction to ambient  
(3) Mounted on 30 mm x 30 mm aluminum PCB; thermal resistance  $R_{\theta JM}$  - junction to mount

| ORDERING INFORMATION (Example) |                 |                        |               |                                    |
|--------------------------------|-----------------|------------------------|---------------|------------------------------------|
| PREFERRED P/N                  | UNIT WEIGHT (g) | PREFERRED PACKAGE CODE | BASE QUANTITY | DELIVERY MODE                      |
| V8P6-M3/86A                    | 0.10            | 86A                    | 1500          | 7" diameter plastic tape and reel  |
| V8P6-M3/87A                    | 0.10            | 87A                    | 6500          | 13" diameter plastic tape and reel |
| V8P6HM3_A/H <sup>(1)</sup>     | 0.10            | H                      | 1500          | 7" diameter plastic tape and reel  |
| V8P6HM3_A/I <sup>(1)</sup>     | 0.10            | I                      | 6500          | 13" diameter plastic tape and reel |

**Note**

- (1) AEC-Q101 qualified

**RATINGS AND CHARACTERISTICS CURVES** ( $T_A = 25\text{ }^\circ\text{C}$  unless otherwise noted)

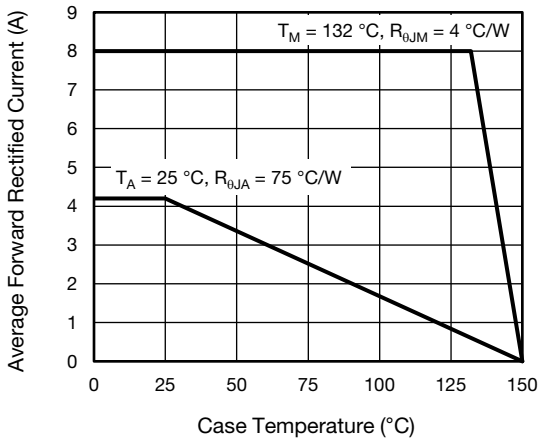


Fig. 1 - Forward Current Derating Curve

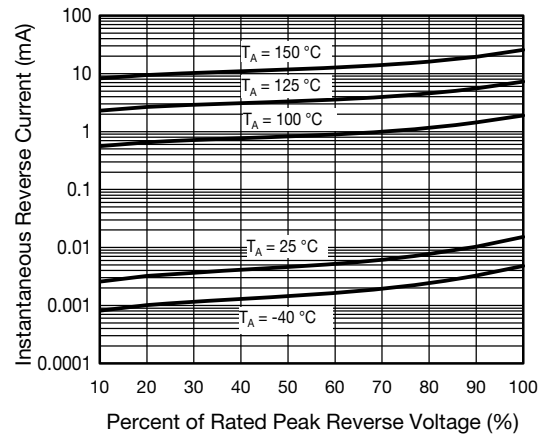


Fig. 4 - Typical Reverse Leakage Characteristics Per Diode

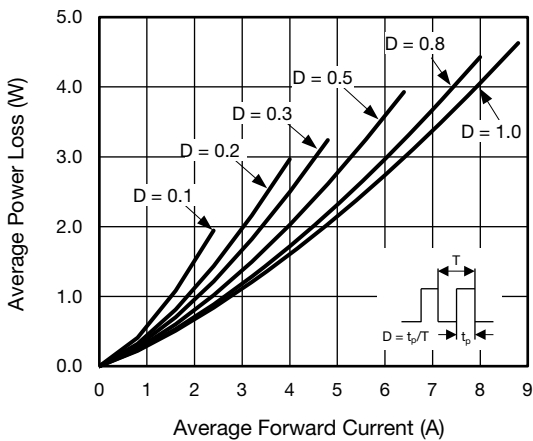


Fig. 2 - Forward Power Loss Characteristics

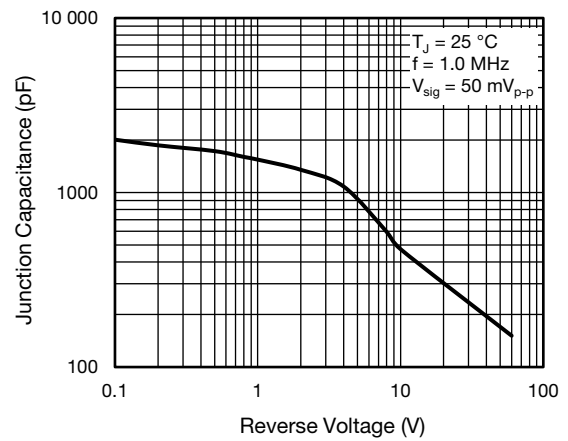


Fig. 5 - Typical Junction Capacitance

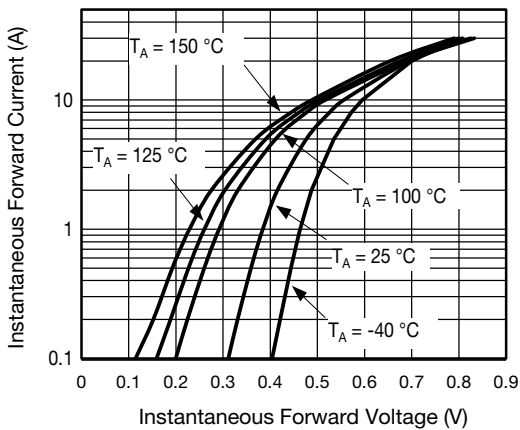


Fig. 3 - Typical Instantaneous Forward Characteristics

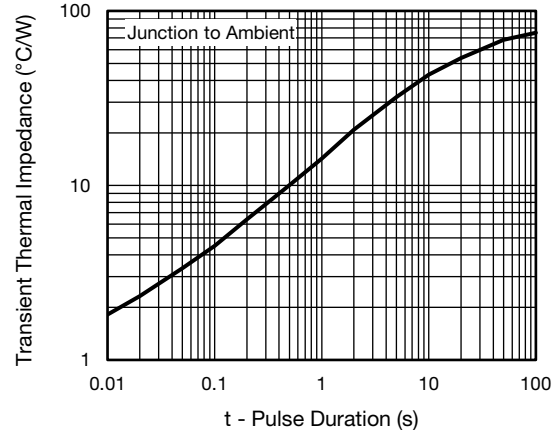
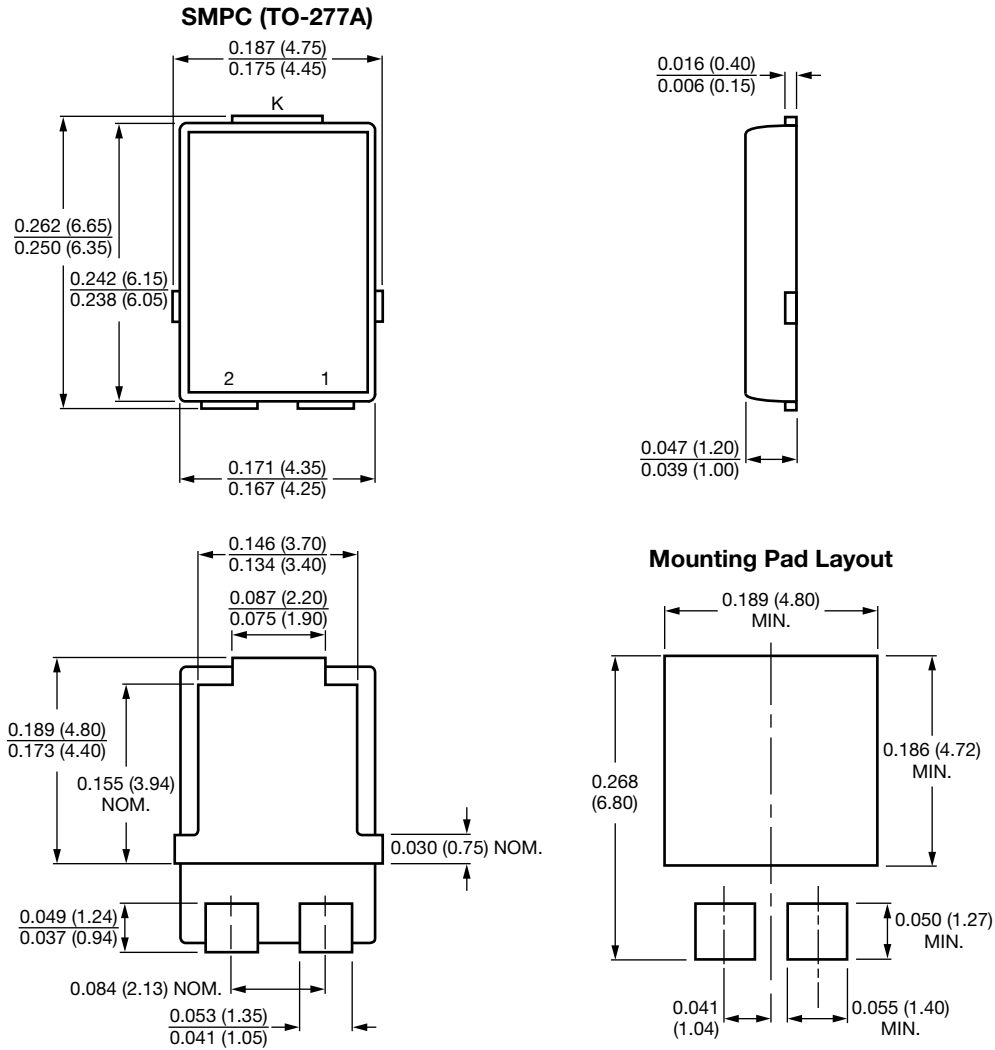


Fig. 6 - Typical Transient Thermal Impedance

**PACKAGE OUTLINE DIMENSIONS** in inches (millimeters)



Conform to JEDEC® TO-277A



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